

Structural Epoxy Adhesive

Description

9200 is a toughened, two-part epoxy adhesive, designed to create long-lasting load-bearing joints. It adheres strongly to a wide range of materials that are difficult to bond to, including glass, ceramics, metals, engineered thermoplastics, and thermoset laminates, such as SMC (sheet molding compound) and GRP (glass-reinforced plastics). It creates tough vibration-resistant bonds, and is especially useful for joining dissimilar materials that will experience thermal cycling stresses.

This product also provides excellent electrical insulation, and protects against static discharges, thermal shocks, galvanic corrosion, environmental humidity, salt water, fungus, and many harsh chemicals.

It is smooth, non-sagging and thixotropic, so it is excellent for use on vertical surfaces and for gap filling. It is also useful for potting electronics in enclosures with gaps where a non-thixotropic encapsulant would flow through.

For a flame retardant version, use 9200FR.

Features and Benefits

- *1:1 mix ratio*
- *Excellent bond strength to a wide variety of substrates*
- *Extreme resistance to vibration and temperature cycling*
- *Superior tensile, compressive and lap shear strength*
- *Excellent chemical resistance*
- *Excellent electrical insulating characteristics*
- *Non-sagging and gap-filling*
- *Ideal for bonding dissimilar materials*
- *Low shrinkage*
- *RoHS 3 compliant*

Usage Parameters

Properties	Value
Working life @22 °C [72 °F]	30 min
Shelf life @22 °C [72 °F]	≥3 y
Full cure @22 °C [72 °F]	48 h
Full cure @40 °C [104 °F]	16 h
Full cure @65 °C [149 °F]	1.5 h
Full cure @80 °C [176 °F]	1 h
Full cure @100 °C [212 °F]	15 min

Temperature Ranges

Properties	Value
Constant service temperature	-40 to 150 °C [-40 to 302 °F]
Storage temperature	16 to 27 °C [61 to 81 °F]

Cured Properties

Physical Properties	Method	Value ^{a)}
Color	Visual	Yellowish grey
Density @26 °C [79 °F]	ASTM D 1475	1.23 g/mL
Hardness	Shore D Durometer	76D
Tensile strength	ASTM D 638	16 N/mm ² [2 400 lb/in ²]
Compressive strength	ASTM D 695	64 N/mm ² [9 300 lb/in ²]
Lap shear strength (stainless steel)	ASTM D 1002	20 N/mm ² [2 900 lb/in ²]
Lap shear strength (aluminum)	ASTM D 1002	22 N/mm ² [3 200 lb/in ²]
Lap shear strength (copper)	ASTM D 1002	18 N/mm ² [2 700 lb/in ²]
Lap shear strength (brass)	ASTM D 1002	19 N/mm ² [2 800 lb/in ²]
Lap shear strength (polycarbonate)	ASTM D 1002	3.5 N/mm ² [500 lb/in ²]
Lap shear strength (ABS)	ASTM D 1002	3.4 N/mm ² [500 lb/in ²]

Note: Specifications are for epoxy samples cured at 40 °C for 16 h and conditioned at ambient temperature and humidity.

a) N/mm² = mPa; lb/in² = psi

Cured Properties

Electrical Properties	Method	Value
Breakdown voltage @2.5 mm	ASTM D 149	41 500 V [41.5 kV]
Dielectric strength @2.5 mm	ASTM D 149	503 V/mil [19.8 kV/mm]
Breakdown voltage @3.175 mm [1/8"]	Reference fit ^{a)}	51 000 V [51 kV]
Dielectric strength @3.175 mm [1/8"]	Reference fit ^{a)}	408 V/mil [16.1 kV/mm]
Volume resistivity	ASTM D 257	$2.5 \times 10^{13} \Omega \cdot \text{cm}$
Volume conductivity	ASTM D 257	$4 \times 10^{-14} \text{ S/cm}$
Thermal Properties	Method	Value
Glass transition temperature (T_g)	ASTM E 3418	44 °C [111 °F]
CTE ^{b)} prior T_g after T_g	ASTM E 831 ASTM E 831	95 ppm/°C [203 ppm/°F] 215 ppm/°C [419 ppm/°F]
Thermal conductivity @25 °C [77 °F]	ASTM E 1461 92	0.3 W/(m·K)
Thermal diffusivity @25 °C [77 °F]	ASTM E 1461 92	0.2 mm ² /s
Specific heat capacity @25 °C [77 °F]	ASTM E 1461 92	1.4 J/(g·K)

Note: Specifications are for epoxy samples cured at 40 °C for 16 h and conditioned at ambient temperature and humidity.

a) To allow comparison between products, the dielectric strength was recalculated with the Tautscher equation fitted to 5 experimental values and extrapolated to a standard thickness of 1/8" (3.175 mm).

b) Coefficient of Thermal Expansion (CTE) units are in ppm/°C = in/in/°C $\times 10^{-6}$ = unit/unit/°C $\times 10^{-6}$

Uncured Properties

Physical Properties	Mixture (A:B)
Color	Yellowish grey
Density	1.25 g/mL
Mix ratio by volume	1:1
Mix ratio by weight	1:1

Physical Properties	Part A	Part B
Color	Light grey	Cream yellow
Viscosity @25 °C [77 °F]	295 000 cP [295 Pa·s] ^{a)}	170 000 cP [170 Pa·s] ^{b)}
Density	1.25 g/mL	1.25 g/mL
Odor	Mild	Ammonia-like

a) Brookfield viscometer at 30 rpm with spindle RV S96.

b) Brookfield viscometer at 50 rpm with spindle RV S96.

Compatibility

Adhesion—9200 epoxy adheres to most plastics and metals used to house printed circuit assemblies; however, it is not compatible with contaminants like water, oil, or greasy flux residues, which may affect adhesion. In case of contamination, first clean the surface to be coated with MG Chemicals 824 Isopropyl Alcohol.

For substrate substances with weak adhesion strengths, surface preparation such as sanding or pre-coating with a suitable primer may improve adhesion.

Chemical resistance—Once cured, the epoxy adhesive is inert under normal conditions. It will resist water and salt exposure.

It is expected to resist short term exposures to fuels or similar non-polar organic solvents, but it is not suitable for prolonged exposures. Avoid use with strong acids, strong bases, or strong oxidizers.

Storage

Store between 16 to 27 °C [61 to 81 °F] in a dry area, away from sunlight. Some of the components are sensitive to air, always recap firmly when not in use to maximize shelf life.

Substrate Adhesion (In Decreasing Order)

Physical Properties	Adhesion
Aluminum	Stronger
Steel	
Copper/brass	
Fiberglass	
Wood	
Paper, Fiber	
Glass	
Rubber	
Polycarbonate	
Acrylic	
Polypropylene	
	Weaker
	Does not bond

Health and Safety

Please see the 9200 Safety Data Sheet (SDS) parts A and B for further details on transportation, storage, handling, safety guidelines, and regulatory compliance.

Application Instructions

For best results, follow the procedure below. Heat cure to achieve optimal conductivity.

Syringe or cartridge:

To insert the cartridge in the gun, see the Application Guide section for dispensing accessories.

1. Twist and remove the cap from the cartridge or syringe. Do not discard cap.
2. Dispense a small amount to ensure even flow of both parts.
3. (Optional) Attach a static mixer to the 9200-50ML.
 - a. Dispense and discard 3 to 5 mL of the product to ensure a homogeneous mixture.
 - b. After use, dispose of static mixer.
4. Without a static mixer, dispense material on a mixing surface or container, and thoroughly mix parts A and B together.
5. To stop the flow, pull back on the plunger.
6. Clean nozzle to prevent contamination and material buildup.
7. Replace the cap on the cartridge or syringe.

Cure Instructions

Room temperature cure:

- Let cure at room temperature for 48 h.

Heat cure:

- Put in oven at 40 °C [104 °F] for 16 h.
—OR—
- Put in oven at 65 °C [149 °F] for 1.5 h.
—OR—
- Put in oven at 80 °C [176 °F] for 1 h.
—OR—
- Put in oven at 100 °C [176 °F] for 15 min.

Dispensing Accessories

Consult the table below for appropriate accessory selection. See the [Application Guide](#) for instructions on using the dispensing accessories.

Cat. No.	Dispensing Gun	Static Mixer
9200-25ML	N/A	N/A
9200-50ML	8DG-50-1-1	8MT-50, 8MT-50FT ^{a)}

a) 8MT-50-FT should only be used with a pneumatic dispenser.

Packaging and Supporting Products

Cat. No.	Packaging	Net Volume	Net Weight	Packaged Weight
9200-25ML	Dual syringe	25 mL [0.84 fl oz]	31.3 g [1 oz]	85 g [0.19 lb]
9200-50ML	Dual cartridge	45 mL [1.52 fl oz]	56.3 g [1.81 oz]	103 g [0.23 lb]

Technical Support

Please contact us regarding any questions, suggestions for improvements, or problems with this product. Application notes, instructions and FAQs are located at www.mgchemicals.com.

Email: support@mgchemicals.com

Phone: +(1) 800-340-0772 (Canada, Mexico & USA)
+(1) 905-331-1396 (International)
+(44) 1663 362888 (UK & Europe)

Fax: +(1) 905-331-2862 or +(1) 800-340-0773

Mailing address: Manufacturing & Support
1210 Corporate Drive
Burlington, Ontario, Canada
L7L 5R6

Head Office
9347-193rd Street
Surrey, British Columbia, Canada
V4N 4E7

Disclaimer

This information is believed to be accurate. It is intended for professional end users who have the skills required to evaluate and use the data properly. M.G. Chemicals Ltd. does not guarantee the accuracy of the data and assumes no liability in connection with damages incurred while using it.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9